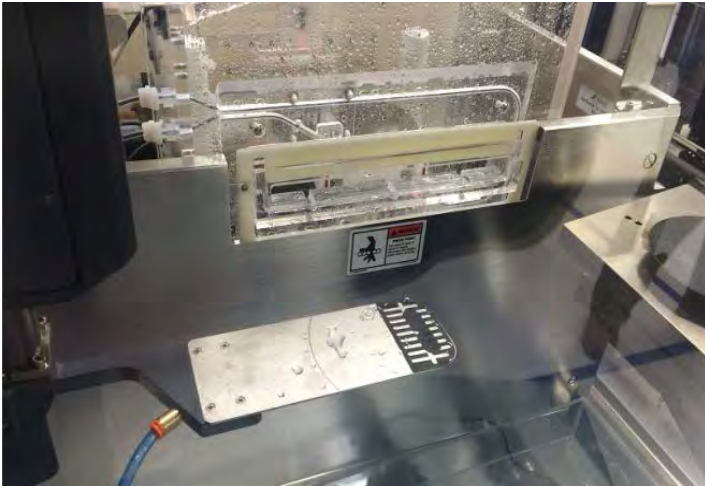




AMAT Mirra Platform Breakage Reduction Robot End Effector Pad



Overview

The wet robot end effector blade pad is a consumable part used for wafer transferring. It is also a protective media for direct contact with back side of the wafer.

Upgrade Details

This exclusive Entrepix only upgrade is a wet robot blade end effector pad that exposes the wafer to less vacuum stress during wafer handling. This upgrade is a must for customers with high stress wafers or delicate wafer materials. This design also improves yield on some silicon wafer based products.

